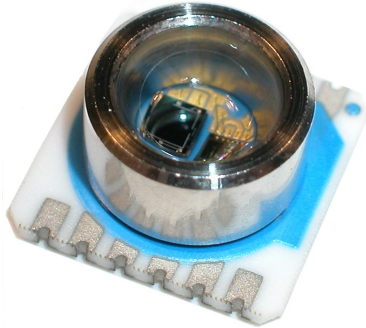**measurement**
S P E C I A L T I E S

MS5801-01BA Altimeter Module

- **High resolution module, 10cm**
- **Fast conversion down to 1 ms**
- **Low power, 1 µA (standby < 0.15 µA)**
- **Integrated digital pressure sensor (24 bit ΔΣ ADC)**
- **Supply voltage 1.8 to 3.6 V**
- **Operating range: 10 to 1300 mbar, -40 to +125 ℃**
- **I²C and SPI interface up to 20 MHz**
- **No external components (Internal oscillator)**
- **Excellent long term stability**
- **Hermetically sealable for outdoor devices**

DESCRIPTION

The MS5801-01BA is a new generation of high resolution altimeter sensors from MEAS Switzerland with SPI and I²C bus interface. It is optimized for depth meters and altimeters with an altitude resolution of 10 cm. The sensor module includes a high linearity pressure sensor and an ultra low power 24 bit ΔΣ ADC with internal factory calibrated coefficients. It provides a precise digital 24 Bit pressure and temperature value and different operation modes that allow the user to optimize for conversion speed and current consumption. A high resolution temperature output allows the implementation of an altimeter/thermometer function without any additional sensor. The MS5801-01BA can be interfaced to any microcontroller. The communication protocol is simple, without the need of programming internal registers in the device. The gel protection and antimagnetic stainless steel cap allows the use in 100m waterproof altimeter/compass watches. This new sensor module generation is based on leading MEMS technology and latest benefits from MEAS proven experience and know-how in high volume manufacturing of altimeter modules, which have been widely used for over a decade. The sensing principle employed leads to very low hysteresis and high stability of both pressure and temperature signal.

FEATURES

FIELD OF APPLICATION

- Mobile altimeter / barometer systems
- Weather control systems
- Adventure or multi-mode watches
- Variometers
- Dataloggers

FUNCTIONAL BLOCK DIAGRAM
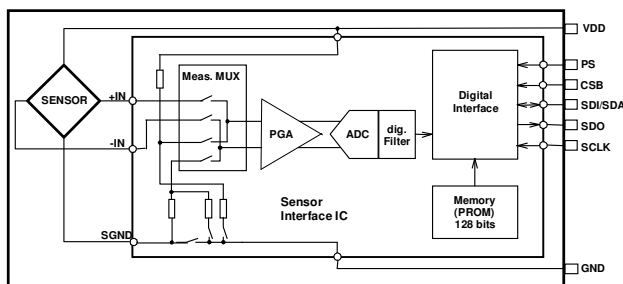
TECHNICAL DATA

Sensor Performances (V_{DD} = 3 V)				
Pressure	**Min**	**Typ**	**Max**	**Unit**
Range	10		1300	mbar
ADC		24		bit
Resolution (1)		0.065 / 0.042 / 0.027 / 0.018 / 0.012		mbar
Accuracy 25℃, 750 to 1100 mbar	-1.5		+1.5	mbar
Accuracy -20℃ to + 85℃, 300 to 1100 mbar (2)	-2.5		+2.5	mbar
Response time		0.5 / 1.1 / 2.1 / 4.1 / 8.22		ms
Long term stability		-1		mbar/yr
Temperature	**Min**	**Typ**	**Max**	**Unit**
Range	-40		+125	℃
Resolution		<0.01		℃
Accuracy	-0.8		+0.8	℃

Notes: (1) Oversampling Ratio: 256 / 512 / 1024 / 2048 / 4096
(2) With autozero at one pressure point

MS5801-01BA Altimeter Module

PERFORMANCE SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Conditions	Min.	Typ.	Max	Unit
Supply voltage	V_{DD}		-0.3		+4.0	V
Storage temperature	T_S		-40		+125	℃
Overpressure	P_{max}	100m, ISO2281			10	bar
Maximum Soldering Temperature	T_{max}	40 sec max			250	℃
ESD rating		Human Body Model	-4		+4	kV
Latch up		JEDEC standard No 78	-100		+100	mA

ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Conditions		Min.	Typ.	Max	Unit
Operating Supply voltage	V_{DD}			1.8	3.0	3.6	V
Operating Temperature	T			-40	+25	+125	℃
Supply current (1 sample per sec.)	I_{DD}	OSR	4096		12.5		µA
			2048		6.3		
			1024		3.2		
			512		1.7		
			256		0.9		
Peak supply current		during conversion			1.4		mA
Standby supply current		at 25℃			0.02	0.14	µA
VDD Capacitor		From VDD to GND		100			nF

ANALOG DIGITAL CONVERTER (ADC)

Parameter	Symbol	Conditions		Min.	Typ.	Max	Unit
Output Word					24		bit
Conversion time	t_c	OSR	4096	7.40	8.22	9.04	ms
			2048	3.72	4.13	4.54	
			1024	1.88	2.08	2.28	
			512	0.95	1.06	1.17	
			256	0.48	0.54	0.60	

MS5801-01BA Altimeter Module

PERFORMANCE SPECIFICATIONS (CONTINUED)

PRESSURE OUTPUT CHARACTERISTICS (V_{DD} = 3 V, T = 25°C UNLESS OTHERWISE NOTED)

Parameter	Conditions		Min.	Typ.	Max	Unit
Operating Pressure Range	P_{range}	Full Accuracy	300		1100	mbar
Extended Pressure Range	P_{ext}	Linear Range of ADC	10		1300	mbar
Absolute Accuracy, no autozero	at 25°C, 700..1100 mbar		-1.5		+1.5	mbar
	at 0..50°C, 300..1100 mbar		-2.0		+2.0	
	at -20..85°C, 300..1100 mbar		-3.5		+3.5	
	at -40..85°C, 300..1100 mbar		-6.0		+6..0	
Absolute Accuracy, autozero at one pressure point	at 25°C, 700..1100 mbar		-0.5		+0.5	mbar
	at 0..50°C, 300..1100 mbar		-1.0		+1.0	
	at -20..85°C, 300..1100 mbar		-2.5		+2.5	
	at -40..85°C, 300..1100 mbar		-5.0		+5.0	
Maximum error with supply voltage	V_{DD} = 1.8 V … 3.6 V		-2		+2	mbar
Long-term stability				-1		mbar/yr
Resolution RMS	OSR	4096		0.012		mbar
		2048		0.018		
		1024		0.027		
		512		0.042		
		256		0.065		

TEMPERATURE OUTPUT CHARACTERISTICS (V_{DD} = 3 V, T = 25°C UNLESS OTHERWISE NOTED)

Parameter	Conditions		Min.	Typ.	Max	Unit
Absolute Accuracy	at 25°C		-0.8		+0.8	°C
	-20..85°C		-2.0		+2.0	
	-40..85°C		-4.0		+4.0	
Maximum error with supply voltage	V_{DD} = 1.8 V … 3.6 V		-0.5		+0.5	°C
Resolution RMS	OSR	4096		0.002		°C
		2048		0.003		
		1024		0.005		
		512		0.008		
		256		0.012		

MS5801-01BA Altimeter Module

PERFORMANCE SPECIFICATIONS (CONTINUED)

DIGITAL INPUTS (CSB, I^{2}C, DIN, SCLK)

Parameter	Symbol	Conditions	Min.	Typ.	Max	Unit
Serial data clock	SCLK	SPI protocol			20	MHz
Input high voltage	V_{IH}	Pins CSB	80% V_{DD}		100% V_{DD}	V
Input low voltage	V_{IL}		0% V_{DD}		20% V_{DD}	V
Input leakage current	$I_{leak25°C}$	at 25°C			0.15	μA

PRESSURE OUTPUTS (I^{2}C, DOUT)

Parameter	Symbol	Conditions	Min.	Typ.	Max	Unit
Output high voltage	V_{OH}	I_{source} = 0.6 mA	80% V_{DD}		100% V_{DD}	V
Output low voltage	V_{OL}	I_{sink} = 0.6 mA	0% V_{DD}		20% V_{DD}	V
Load capacitance	C_{LOAD}				16	pF

MS5801-01BA Altimeter Module
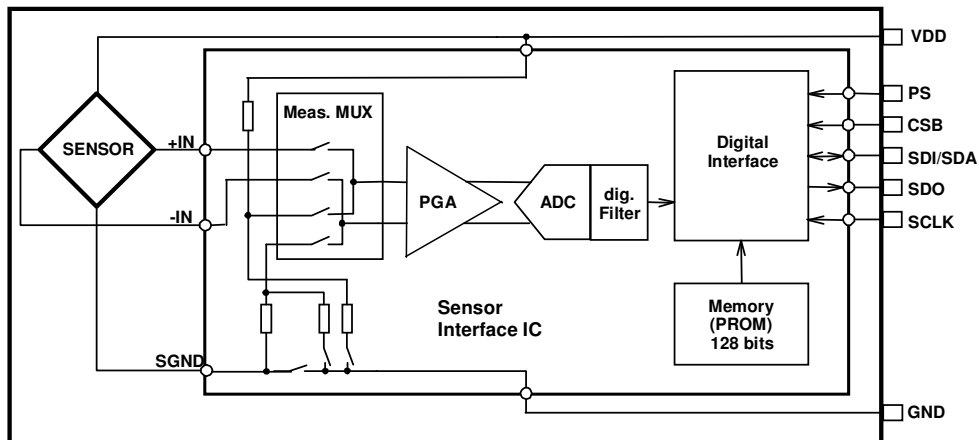
FUNCTIONAL DESCRIPTION

Figure 1: Block diagram of MS5801-01BA

GENERAL

The MS5801-01BA consists of a piezo-resistive sensor and a sensor interface IC. The main function of the MS5801-01BA is to convert the uncompensated analogue output voltage from the piezo-resistive pressure sensor to a 24-bit digital value, as well as providing a 24-bit digital value for the temperature of the sensor.

FACTORY CALIBRATION

Every module is individually factory calibrated at two temperatures and two pressures. As a result, 6 coefficients necessary to compensate for process variations and temperature variations are calculated and stored in the 128-bit PROM of each module. These bits (partitioned into 6 coefficients) must be read by the microcontroller software and used in the program converting D1 and D2 into compensated pressure and temperature values.

SERIAL INTERFACE

The MS5801-01BA has built in two types of serial interfaces: SPI and I^2C. Pulling the Protocol Select pin PS to low selects the SPI protocol, pulling PS to high activates the I^2C bus protocol.

Pin PS	Mode	Pins used
High	I^2C	SDA
Low	SPI	SDI, SDO, CSB

SPI MODE

The external microcontroller clocks in the data through the input SCLK (Serial CLocK) and SDI (Serial Data In). In the SPI mode module can accept both mode 0 and mode 3 for the clock polarity and phase. The sensor responds on the output SDO (Serial Data Out). The pin CSB (Chip Select) is used to enable/disable the interface, so that other devices can talk on the same SPI bus. The CSB pin can be pulled high after the command is sent or after the end of the command execution (for example end of conversion). The best noise performance from the module is obtained when the SPI bus is idle and without communication to other devices during the ADC conversion.

MS5801-01BA Altimeter Module

I^{2}C MODE

The external microcontroller clocks in the data through the input SCLK (Serial CLocK) and SDA (Serial DAta). The sensor responds on the same pin SDA which is bidirectional for the I^{2}C bus interface. So this interface type uses only 2 signal lines and does not require a chip select, which can be favourable to reduce board space. In I^{2}C-Mode the complement of the pin CSB (Chip Select) represents the LSB of the I^{2}C address. It is possible to use two sensors with two different addresses on the I^{2}C bus. The pin CSB shall be connected to VDD or GND (do not leave unconnected!).
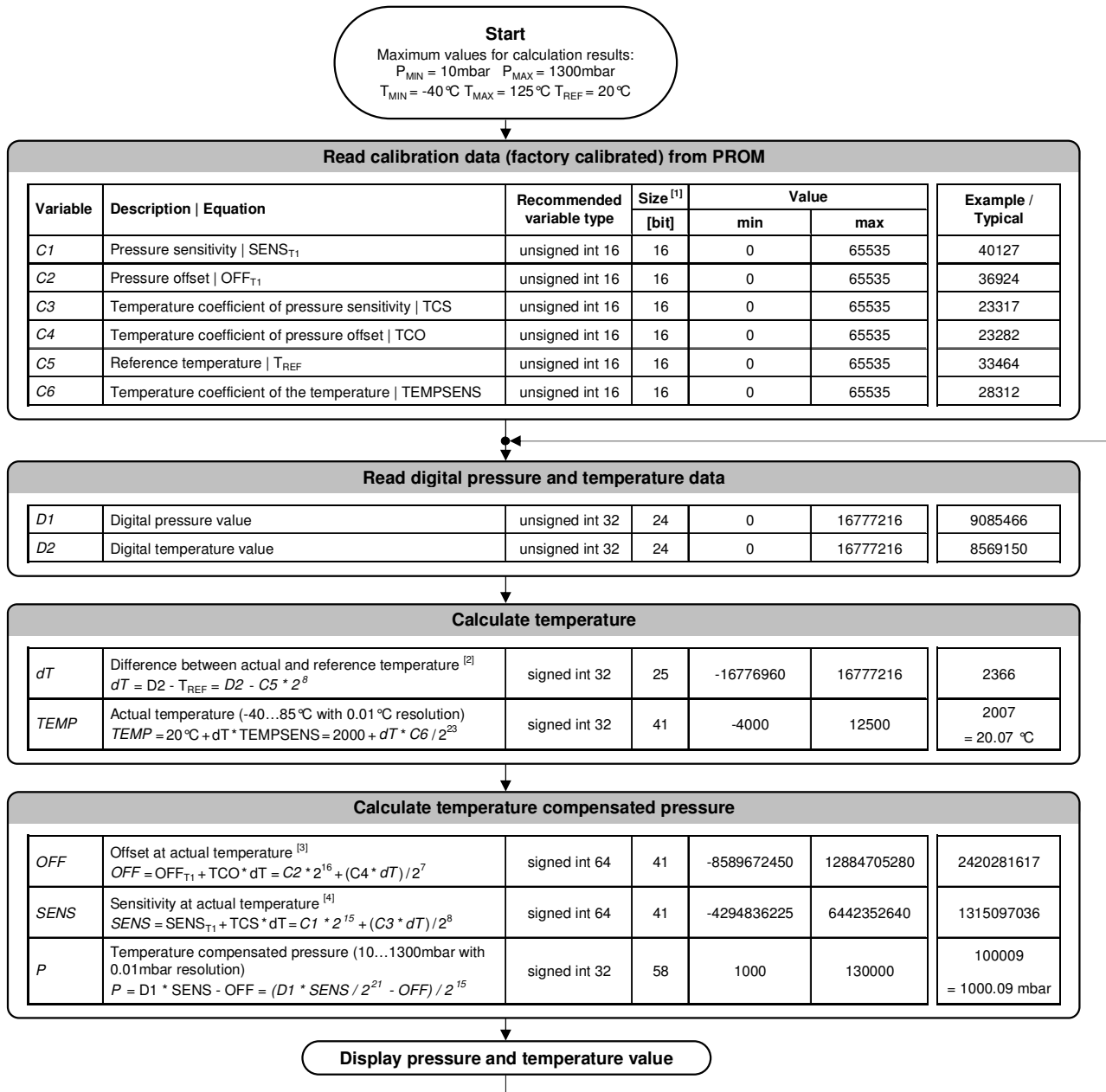
COMMANDS

The MS5801-01BA has only five basic commands:
1. Reset
2. Read PROM (128 bit of calibration words)
3. D1 conversion
4. D2 conversion
5. Read ADC result (24 bit pressure / temperature)

MS5801-01BA Altimeter Module

PRESSURE AND TEMPERATURE CALCULATION

Start
Maximum values for calculation results:
P_{MIN} = 10mbar P_{MAX} = 1300mbar
T_{MIN} = -40℃ T_{MAX} = 125℃ T_{REF} = 20℃

Read calibration data (factory calibrated) from PROM

Variable	Description | Equation	Recommended variable type	Size [1] [bit]	Value min	Value max	Example / Typical
C1	Pressure sensitivity | $SENS_{T1}$	unsigned int 16	16	0	65535	40127
C2	Pressure offset | OFF_{T1}	unsigned int 16	16	0	65535	36924
C3	Temperature coefficient of pressure sensitivity | TCS	unsigned int 16	16	0	65535	23317
C4	Temperature coefficient of pressure offset | TCO	unsigned int 16	16	0	65535	23282
C5	Reference temperature | T_{REF}	unsigned int 16	16	0	65535	33464
C6	Temperature coefficient of the temperature | TEMPSENS	unsigned int 16	16	0	65535	28312

Read digital pressure and temperature data

Variable	Description | Equation	Recommended variable type	Size [bit]	Value min	Value max	Example / Typical
D1	Digital pressure value	unsigned int 32	24	0	16777216	9085466
D2	Digital temperature value	unsigned int 32	24	0	16777216	8569150

Calculate temperature

Variable	Description | Equation	Recommended variable type	Size [bit]	Value min	Value max	Example / Typical
dT	Difference between actual and reference temperature [2] $dT = D2 - T_{REF} = D2 - C5 * 2^8$	signed int 32	25	-16776960	16777216	2366
TEMP	Actual temperature (-40…85℃ with 0.01℃ resolution) $TEMP = 20℃ + dT * TEMPSENS = 2000 + dT * C6 / 2^{23}$	signed int 32	41	-4000	12500	2007 = 20.07 ℃

Calculate temperature compensated pressure

Variable	Description | Equation	Recommended variable type	Size [bit]	Value min	Value max	Example / Typical
OFF	Offset at actual temperature [3] $OFF = OFF_{T1} + TCO * dT = C2 * 2^{16} + (C4 * dT) / 2^7$	signed int 64	41	-8589672450	12884705280	2420281617
SENS	Sensitivity at actual temperature [4] $SENS = SENS_{T1} + TCS * dT = C1 * 2^{15} + (C3 * dT) / 2^8$	signed int 64	41	-4294836225	6442352640	1315097036
P	Temperature compensated pressure (10…1300mbar with 0.01mbar resolution) $P = D1 * SENS - OFF = (D1 * SENS / 2^{21} - OFF) / 2^{15}$	signed int 32	58	1000	130000	100009 = 1000.09 mbar

Display pressure and temperature value

Notes
[1]   Maximal size of intermediate result during evaluation of variable
[2]   min and max have to be defined
[3]   min and max have to be defined
[4]   min and max have to be defined

Figure 2: Flow chart for pressure and temperature reading and software compensation.

SECOND ORDER TEMPERATURE COMPENSATION

To be defined

Figure 3: Flow chart for pressure and temperature to the optimum accuracy.

MS5801-01BA Altimeter Module

SPI INTERFACE

COMMANDS

Size of each command is 1 byte (8 bits) as described in the table below. After ADC read commands the device will return 24 bit result and after the PROM read 16bit result. The address of the PROM is embedded inside of the PROM read command using the a2, a1 and a0 bits.

	Command byte								hex value
Bit number	0	1	2	3	4	5	6	7	
Bit name	PRM	COV	-	Typ	Ad2/Os2	Ad1/Os1	Ad0/Os0	Stop	
Command									
Reset	0	0	0	1	1	1	1	0	0x1E
Convert D1 (OSR=256)	0	1	0	0	0	0	0	0	0x40
Convert D1 (OSR=512)	0	1	0	0	0	0	1	0	0x42
Convert D1 (OSR=1024)	0	1	0	0	0	1	0	0	0x44
Convert D1 (OSR=2048)	0	1	0	0	0	1	1	0	0x46
Convert D1 (OSR=4096)	0	1	0	0	1	0	0	0	0x48
Convert D2 (OSR=256)	0	1	0	1	0	0	0	0	0x50
Convert D2 (OSR=512)	0	1	0	1	0	0	1	0	0x52
Convert D2 (OSR=1024)	0	1	0	1	0	1	0	0	0x54
Convert D2 (OSR=2048)	0	1	0	1	0	1	1	0	0x56
Convert D2 (OSR=4096)	0	1	0	1	1	0	0	0	0x58
ADC Read	0	0	0	0	0	0	0	0	0x00
PROM Read	1	0	1	0	Ad2	Ad1	Ad0	0	0xA0 to 0xAE

Figure 4: Command structure

RESET SEQUENCE

The Reset sequence shall be sent once after power-on to make sure that the calibration PROM gets loaded into the internal register. It can be also used to reset the device ROM from an unknown condition
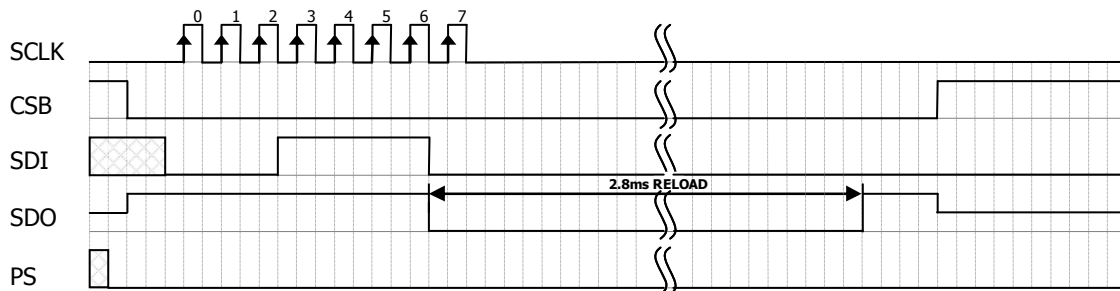
Figure 5: Reset command sequence SPI mode 0
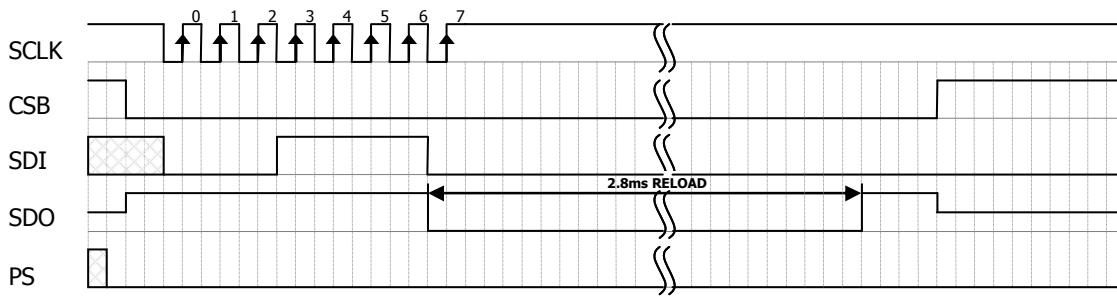
Figure 6: Reset command sequence SPI mode 3

CONVERSION SEQUENCE

The conversion command is used to initiate uncompensated pressure (D1) or uncompensated temperature (D2) conversion. The chip select can be disabled during this time to communicate with other devices.

After the conversion, using ADC read command the result is clocked out with the MSB first. If the conversion is not executed before the ADC read command, or the ADC read command is repeated, it will give 0 as the output result. If the ADC read command is sent during conversion the result will be 0, the conversion will not stop and the final result will be wrong. Conversion sequence sent during the already started conversion process will yield incorrect result as well.
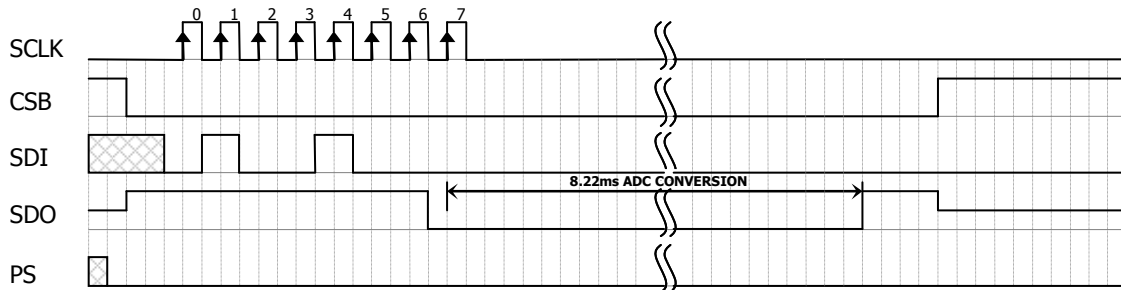
Figure 7: Conversion out sequence, Typ=d1, OSR = 4096
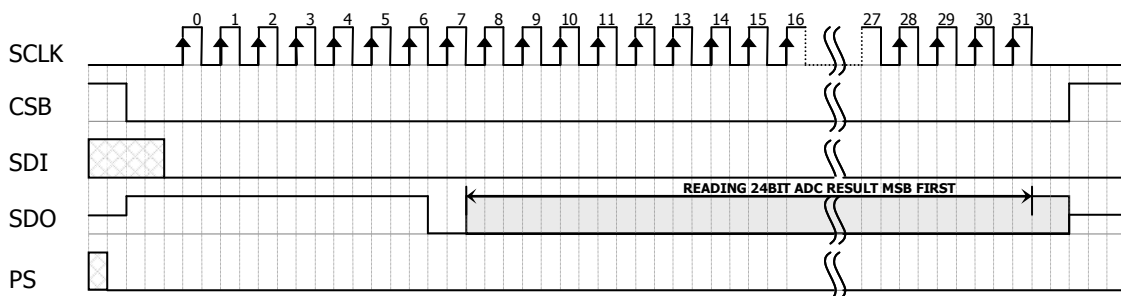
Figure 8: ADC Read sequence

PROM READ SEQUENCE

The read command for PROM shall be executed once after reset by the user to read the content of the calibration PROM and to calculate the calibration coefficients. There are in total 8 addresses resulting in a total memory of 128 bit. Address 0 contains factory data and the setup, addresses 1-6 calibration coefficients and address 7 contains the serial code and CRC. The command sequence is 8 bits long with a 16 bit result which is clocked with the MSB first.

MS5801-01BA Altimeter Module
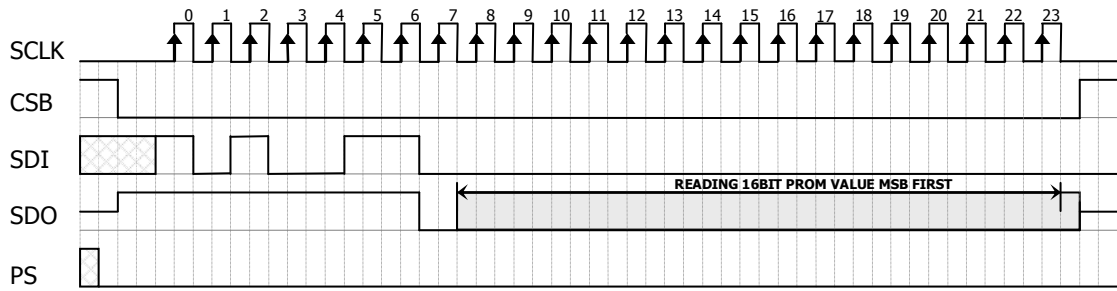
Figure 9: PROM Read sequence, address = 011 (Coefficient 3).

I²C INTERFACE

COMMANDS

Each I²C communication message starts with the start condition and it is ended with the stop condition. The MS5801-01BA address is 111011Cx, where C is the complementary value of the pin CSB. Since the IC does not have a microcontroller inside, the commands for I²C and SPI are quite similar.

RESET SEQUENCE

The reset can be sent at any time. In the event that there is not a successful power on reset this may be caused by the SDA being blocked by the module in the acknowledge state. The only way to get the MS5801-01BA to function is to send several SCLKs followed by a reset sequence or to repeat power on reset.
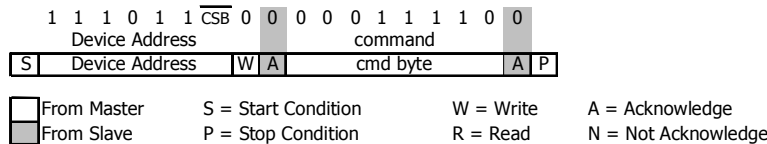
Figure 10: I²C Reset Command

PROM READ SEQUENCE

The PROM Read command consists of two parts. First command sets up the system into PROM read mode. The second part gets the data from the system.
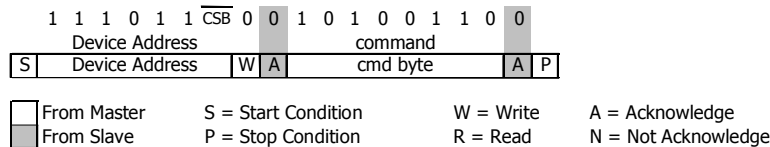
Figure 11: I²C Command to read memory address= 011 (Coefficient 3)
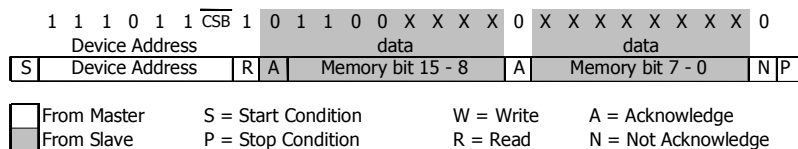
Figure 12: I²C answer from MS5801-01BA

MS5801-01BA Altimeter Module

CONVERSION SEQUENCE

A conversion can be started by sending the command to MS5801-01BA. When command is sent to the system it stays busy until conversion is done. When conversion is finished the data can be accessed by sending a Read command, when an acknowledge appears from the MS5801-01BA, 24 SCLK cycles may be sent to receive all result bits. Every 8 bit the system waits for an acknowledge signal.
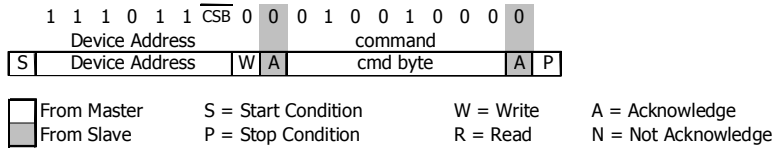
	1 1 1 0 1 1 $\overline{CSB}$ 0	0	0 0 1 0 0 1 0 0 0	0	
	Device Address		command		
S	Device Address	W A	cmd byte	A	P

From Master	S = Start Condition	W = Write	A = Acknowledge
From Slave	P = Stop Condition	R = Read	N = Not Acknowledge

Figure 13: I²C Command to initiate a pressure conversion (OSR=4096, typ=D1)

	1 1 1 0 1 1 $\overline{CSB}$ 0	0	0 0 0 0 0 0 0 0 0	0	
	Device Address		command		
S	Device Address	W A	cmd byte	A	P

From Master	S = Start Condition	W = Write	A = Acknowledge
From Slave	P = Stop Condition	R = Read	N = Not Acknowledge
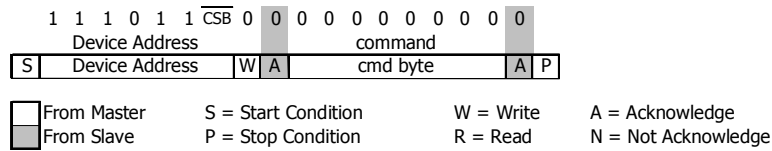
Figure 14: I²C ADC read sequence

	1 1 1 0 1 1 $\overline{CSB}$ 1	0 X X X X X X X 0	X X X X X X X X 0	X X X X X X X X 0	
	Device Address	data	data	data	
S	Device Address	R A Data 23-16	A Data 8 - 15	A Data 7 - 0	N P

From Master	S = Start Condition	W = Write	A = Acknowledge
From Slave	P = Stop Condition	R = Read	N = Not Acknowledge
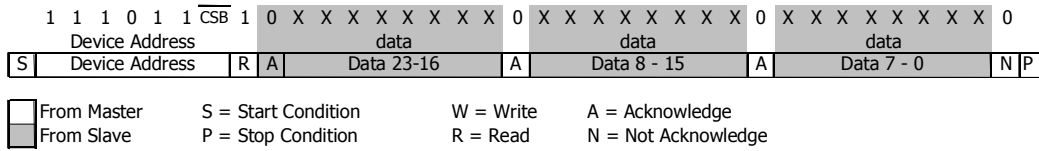
Figure 15: I²C answer from MS5801-01BA

CYCLIC REDUNDANCY CHECK (CRC)

MS5801-01BA contains a PROM memory with 128-Bit. A 4-bit CRC has been implemented to check the data validity in memory. The application note AN521 describes in detail CRC-4 code used.

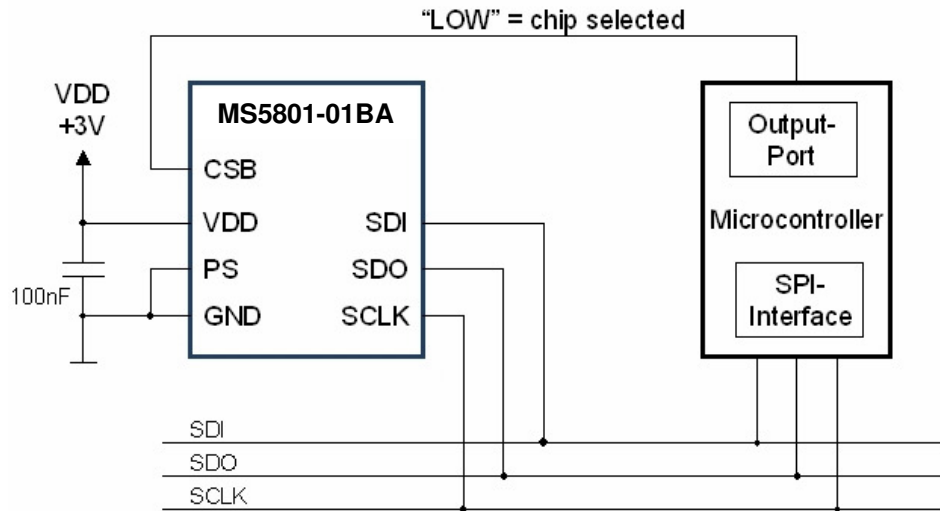| Add	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	16 bit reserved for manufacturer															
1	Coefficient 1 (16 bit unsigned)															
2	Coefficient 2 (16 bit unsigned)															
3	Coefficient 3 (16 bit unsigned)															
4	Coefficient 4 (16 bit unsigned)															
5	Coefficient 5 (16 bit unsigned)															
6	Coefficient 6 (16 bit unsigned)															
7														CRC		

Figure 16: Memory PROM mapping

MS5801-01BA Altimeter Module

APPLICATION CIRCUIT

The MS5801-01BA is a circuit that can be used in conjunction with a microcontroller in mobile altimeter applications. It is designed for low-voltage systems with a supply voltage of 3 V.
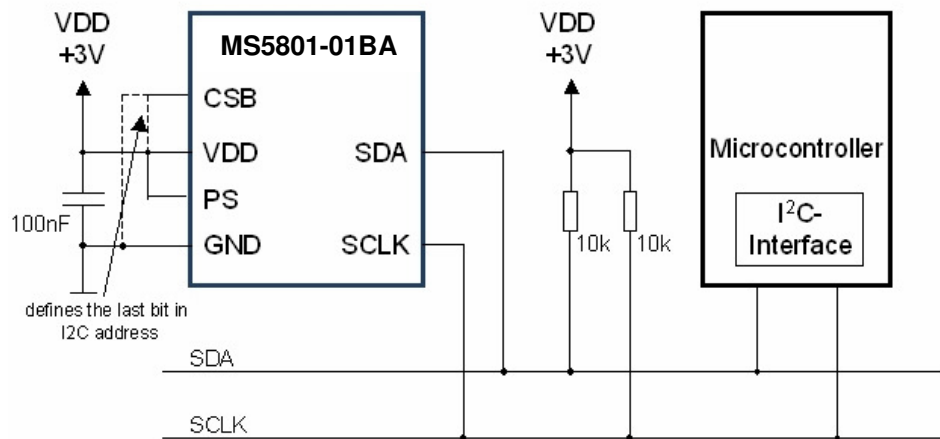

Figure 17: Typical application circuit with SPI / I^2C protocol communication

MS5801-01BA Altimeter Module

DEVICE PACKAGE OUTLINES

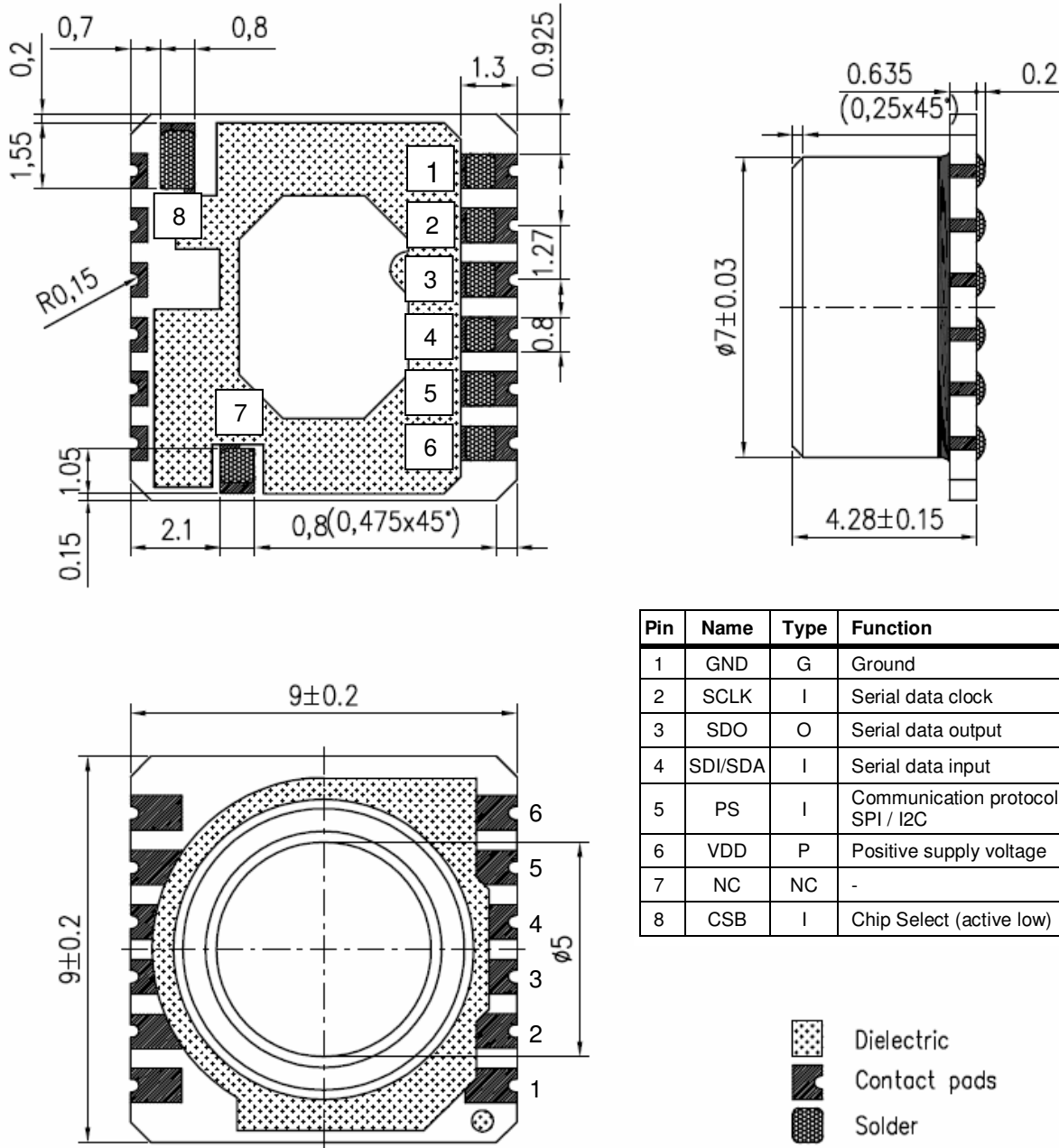| Pin	Name	Type	Function
1	GND	G	Ground
2	SCLK	I	Serial data clock
3	SDO	O	Serial data output
4	SDI/SDA	I	Serial data input
5	PS	I	Communication protocol select SPI / I2C
6	VDD	P	Positive supply voltage
7	NC	NC	-
8	CSB	I	Chip Select (active low)

Figure 18: Device package outline of MS5801-01BA

Notes: (1) Dimensions in mm
(2) General tolerance ±0.1
(3) Cap centering ± 0.15 from center of the ceramic

MS5801-01BA Altimeter Module

DEVICE PACKAGE OUTLINES (CONTINUATION)

Pad layout for bottom side of MS5801-01BA soldered onto printed circuit board
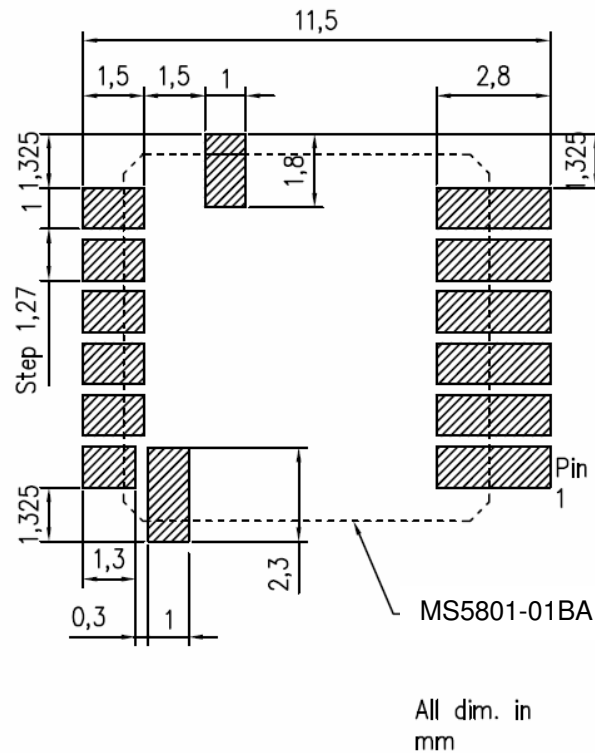
Fig. 19: Layout for bottom side

The pad layout for top side of MS5801-01BA soldered onto printed circuit board is **only** available on request.

MS5801-01BA Altimeter Module

MOUNTING AND ASSEMBLY CONSIDERATIONS

SOLDERING

Please refer to the application note AN808 available on our website for all soldering issues.

MOUNTING

The MS5801-01BA can be placed with automatic Pick & Place equipment using vacuum nozzles. It will not be damaged by the vacuum. Due to the low stress assembly the sensor does not show pressure hysteresis effects. It is important to solder all contact pads.

CONNECTION TO PCB

The package outline of the module allows the use of a flexible PCB for interconnection. This can be important for applications in watches and other special devices.

SEALING WITH O-RINGS

In products like outdoor watches the electronics must be protected against direct water or humidity. For those products the MS5801-01BA provides the possibility to seal with an O-ring. The protective cap of the MS5801-01BA is made of special anticorrosive stainless steel with a polished surface. In addition to this the MS5801-01BA is filled with silicone gel covering the sensor and the bonding wires. The O-ring (or O-rings) shall be placed at the outer diameter of the metal cap. This method avoids mechanical stress because the sensor can move in vertical direction.

CLEANING

The MS5801-01BA has been manufactured under cleanroom conditions. It is therefore recommended to assemble the sensor under class 10'000 or better conditions. Should this not be possible, it is recommended to protect the sensor opening during assembly from entering particles and dust. To avoid cleaning of the PCB, solder paste of type "no-clean" shall be used. Cleaning might damage the sensor!

ESD PRECAUTIONS

The electrical contact pads are protected against ESD up to 4 kV HBM (human body model). It is therefore essential to ground machines and personnel properly during assembly and handling of the device. The MS5801-01BA is shipped in antistatic transport boxes. Any test adapters or production transport boxes used during the assembly of the sensor shall be of an equivalent antistatic material.

DECOUPLING CAPACITOR

Particular care must be taken when connecting the device to the power supply. A 100 nF ceramic capacitor must be placed as close as possible to the MS5801-01BA VDD pin. This capacitor will stabilize the power supply during data conversion and thus, provide the highest possible accuracy.

MS5801-01BA Altimeter Module

ORDERING INFORMATION

Product Code	Product	Art. No
MS5801-01BA	Altimeter Module	580101BA02-00

FACTORY CONTACTS

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